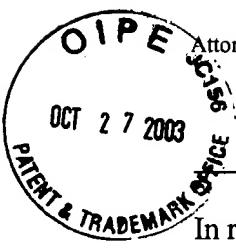


May 6
1731



Attorney Docket # 5123-27RCE

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Bassel H. DAOUD et al.

Serial No.: 09/497,045

Filed: February 02, 2000

For: Mold Incorporating A Heat Source And
Apparatus And Method For Using Such Molds

Examiner: Halpern, Mark
Group Art: 1731

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on

October 24, 2003

(Date of Deposit)

Edward M. Weisz
Name of applicant, assignee or Registered Representative



Signature

October 24, 2003

Date of Signature

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

SECOND SUPPLEMENTAL REVISED AMENDMENT

SIR:

In response to the October 07, 2003 Notice of Non-Compliant Amendment, applicants resubmit herewith a complete "Amendments to the Claims" section of its prior Amendment, which herewith-submitted section has been corrected to remedy the deficiencies noted in the October 07, 2003 Notice of Non-Compliant Amendment.

Amendments to the Claims are reflected in the listing of claims which begins on page 02 of this paper.

Remarks begin on page 08 of this paper.